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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Mitsuo OSADA, et al.

Appln. No.: 10/009,822

Group Art Unit: NOT YET ASSIGNED

Confirmation No.: NOT YET ASSIGNED

Examiner: NOT YET ASSIGNED

Filed: December 13, 2001

For: MATERIAL FOR A HEAT DISSIPATION SUBSTRATE FOR MOUNTING A SEMICONDUCTOR, METHOD OF PRODUCING THE SAME, AND CERAMIC PACKAGE USING THE SAME

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Commissioner for Patents
Office of Initial Patent Examination
Customer Service Center
Washington, D.C. 20231

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Applicant(s): Please change "Yoshinaro Amano, Yamagata, Japan" to --Yoshinari Amano, Yamagata, Japan--.

Verification for the requested correction is indicated on the original Declaration and Power of Attorney filed December 13, 2001.

Respectfully submitted,

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Date: March 18, 2002

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UNITED STATES PATENT AND TRADEMARK OFFICE

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/009,822	12/13/2001	2835	974	Q67726	3	14	4

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CONFIRMATION NO. 6202

FILING RECEIPT



OC00000007425594

Date Mailed: 02/07/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Domestic Priority data as claimed by applicant

THIS APPLICATION IS A 371 OF PCT/JP01/03164 04/12/2001

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Foreign Applications

JAPAN 17584/2000 01/26/2000
 JAPAN 113006/2000 04/14/2000
 JAPAN 372405/2000 12/07/2000

Projected Publication Date: To Be Determined - pending completion of Security Review

Non-Publication Request: No

Early Publication Request: No

Title

Material of heat-dissipating plate on which semiconductor is mounted, method for fabricating the same, and ceramic package produced by using the same

Preliminary Class

361

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Title 37, Code of Federal Regulations, 5.11 & 5.15**

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